

## **Features**

- Shielded construction
- Unit height of 4 mm
- Inductance range: 0.5 to 1.8 µH
- Current up to 13 A
- RoHS compliant\*

## **Applications**

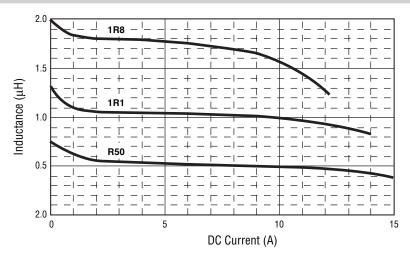
- Input/output of DC/DC converters
- Power supplies for:
  - Portable communications equipment
  - Camcorders
  - LCD TVs

# **SRP1204 Series - Shielded Power Inductors**

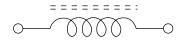
### **Electrical Specifications**

Bourns Part No.	Initial Inductance L0 (μH)	Inductance at Flat Point L1 (μH)	Flat Point Ref. (A)	I rms (A)	I sat (A)	DCR (mΩ) Max.
SRP1204-R50M	0.75 ±20 %	0.55 ±20 %	2.0	13.0	14.0	3.0
SRP1204-1R1M	1.30 ±20 %	1.10 ±20 %	2.0	12.0	13.0	4.5
SRP1204-1R8M	2.00 ±20 %	1.80 ±20 %	2.0	10.0	11.0	6.0

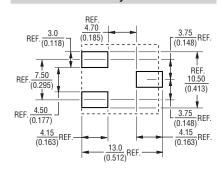
#### L vs I Charts



### **Electrical Schematic**



## **Recommended Layout**



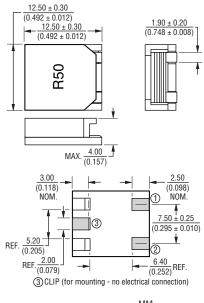
General Specifications
Test Voltage1 V
Test Frequency100 KHz
Reflow Soldering 230 °C; 50 sec. max.
Operating Temperature
40 °C to +125 °C
(Temperature rise included)
Storage Temperature
40 °C to +125 °C
Resistance to Soldering Heat
+245 °C for 10 sec.
Moisture Sensitivity Level1
ESD Classification (HBM)N/A

<sup>1</sup> Circuit design, component, PCB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.

#### **Materials**

Core .......Ferrite ER
Wire .......Enameled copper
Terminal .......Cu/Ni/Sn
Rated Current .....Ind. drops 20 % at Isat
Temperature Rise .....40 °C at rated Irms
Packaging ......800 pcs. per 13-inch reel

## **Product Dimensions**



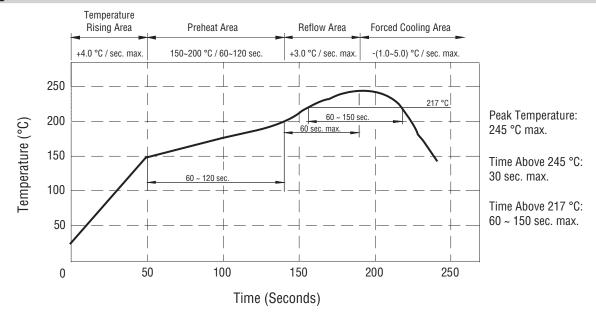
DIMENSIONS:  $\frac{MM}{(INCHES)}$ 

<sup>\*</sup>RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and RoHS Recast 2011/65/EU June 8, 2011.

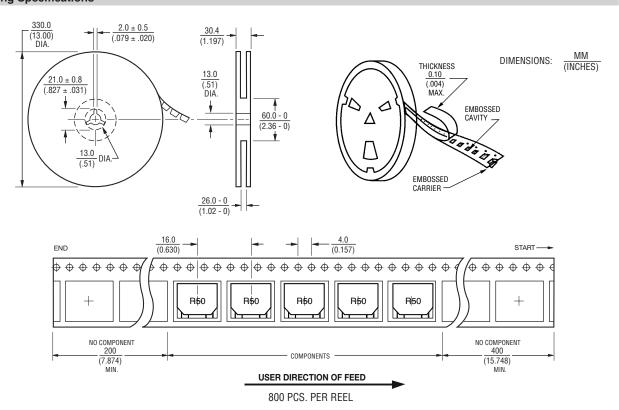
# **SRP1204 Series - Shielded Power Inductors**

## BOURNS®

## **Soldering Profile**



## **Packaging Specifications**



REV. 03/18

Specifications are subject to change without notice.

The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time. Users should verify actual device performance in their specific applications.